

Si7948DP

Vishay Siliconix

Dual N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)		
60	0.075 at V _{GS} = 10 V	4.6		
	0.100 at V _{GS} = 4.5 V	4.0		

FEATURES

- Halogen-free According to IEC 61249-2-21
 Available
- TrenchFET[®] Power MOSFET
- New Low Thermal Resistance PowerPAK[®] Package
- Dual MOSFET for Space Savings

D

N-Channel MOSFET

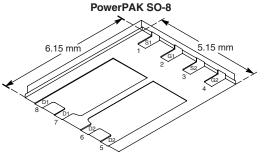
G₁





D₂

N-Channel MOSFET



Bottom View

Ordering Information: Si7948DP-T1-E3 (Lead (Pb)-free) Si7948DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	60		V
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current (T ₁ = 150 °C) ^a	T _A = 25 °C	١-	4.6	3.0	
Continuous Drain Current $(T_j = 150 \text{ C})$	T _A = 70 °C	- ^I D	3.6	2.4	
Pulsed Drain Current		I _{DM}	15		Α
Continuous Source Current (Diode Conduction) ^a		ا _S	2.7	1.2	
Single Avalanche Current	L = 1.0 mH	I _{AS}	15		
Single Avalanche Energy		E _{AS}	11		mJ
Maximum Power Dissipation ^a	T _A = 25 °C	– P _D	3.3	1.4	W
Maximum Fower Dissipation	T _A = 70 °C		2.1	0.9	vv
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C
Soldering Recommendations (Peak Temperature) ^{b, c}			260		-0

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum lumation to Ambienta	t ≤ 10 s R _{thJA} 29 38	38				
Maximum Junction-to-Ambient ^a	Steady State	''thJA	60	85	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	4.0	5.2		

Notes

a. Surface Mounted on 1" x 1" FR4 board.

b. See Solder Profile (<u>www.vishay.com/ppg?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.



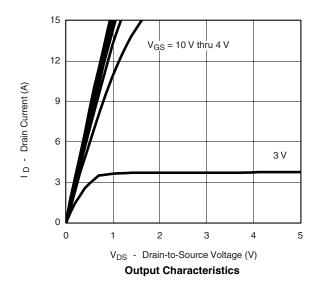
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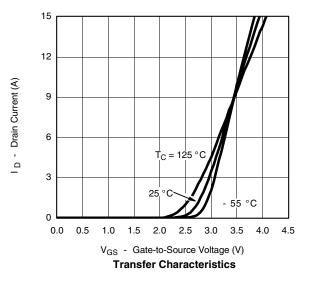
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	• •		•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		3	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 V, V_{GS} = 0 V$			1	μA
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			5	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, V_{GS} = 10 V	15			А
Drain-Source On-State Resistance ^a		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 4.6 \text{ A}$		0.060	0.075	Ω
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_{D} = 4.0 \text{ A}$		0.080	0.100	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 4.6 A		6		S
Diode Forward Voltage ^a	V _{SD}	$I_{S} = 2.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V
Dynamic ^b	•		•	•		
Total Gate Charge	Qg			12	20	
Gate-Source Charge	Q _{gs}	V_{DS} = 30 V, V_{GS} = 10 V, I_D = 15 A		2		nC
Gate-Drain Charge	Q _{gd}			3.5		
Gate Resistance	Rg			1.5		Ω
Turn-On Delay Time	t _{d(on)}			7	20	
Rise Time	t _r	V_{DD} = 30 V, R_L = 2 Ω		8	25	
Turn-Off Delay Time	t _{d(off)}	$t_{d(off)}$ I _D \cong 15 A, V _{GEN} = 10 V, R _g = 2.5 Ω		15	40	ns
Fall Time	t _f			7	20	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.7 A, dl/dt = 100 A/μs		30	60	

Notes: a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



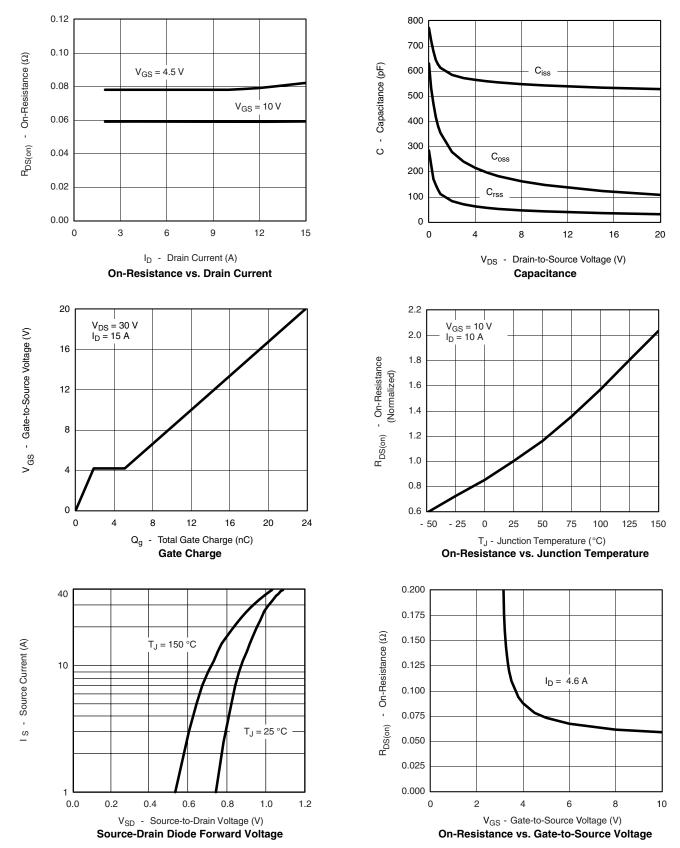




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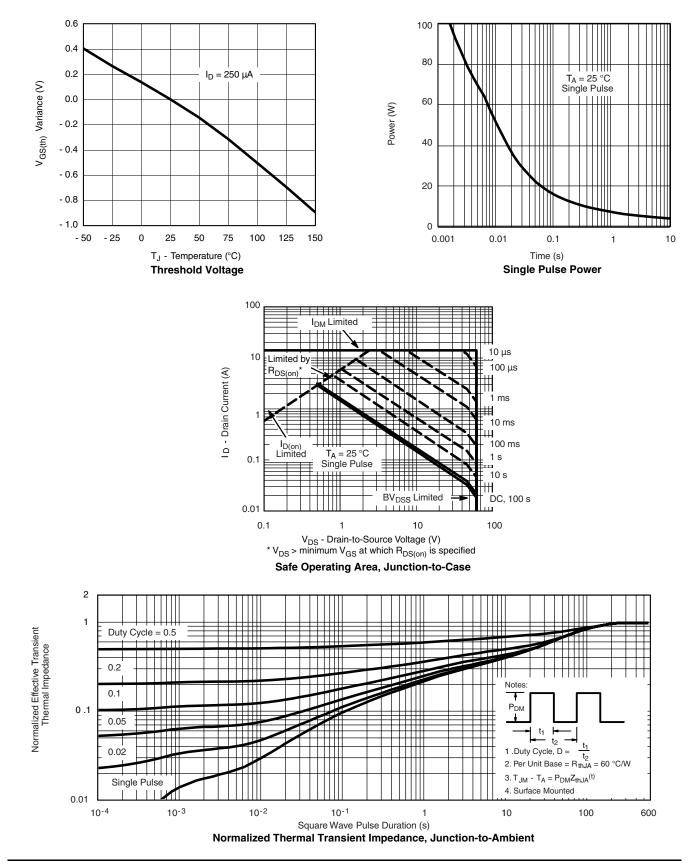
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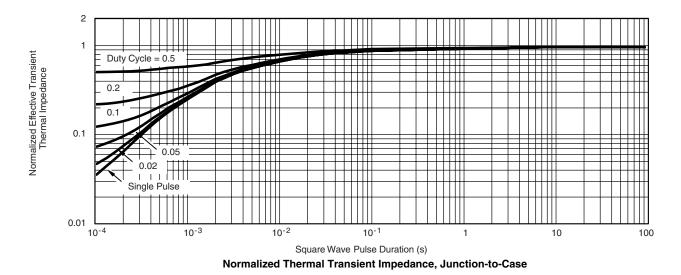




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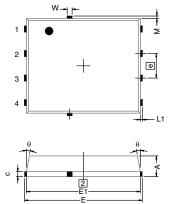


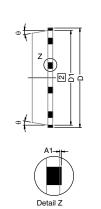
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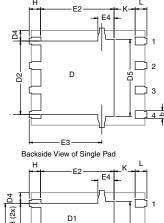


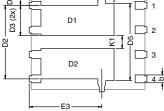
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PowerPAK[®] SO-8, (Single/Dual)









Backside View of Dual Pad

Notes

1. Inch will govern.

2 Dimensions exclusive of mold gate burrs.

3. Dimensions exclusive of mold flash and cutting burrs.

DIM.	MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
A	0.97	1.04	1.12	0.038	0.041	0.044	
A1		-	0.05	0	-	0.002	
b	0.33	0.41	0.51	0.013	0.016	0.020	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	5.05	5.15	5.26	0.199	0.203	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.56	3.76	3.91	0.140	0.148	0.154	
D3	1.32	1.50	1.68	0.052	0.059	0.066	
D4	0.57 typ.			0.0225 typ.			
D5		3.98 typ.			0.157 typ.		
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	5.79	5.89	5.99	0.228	0.232	0.236	
E2 (for AL product)	3.30	3.48	3.66	0.130	0.137	0.144	
E2 (for other product)	3.48	3.66	3.84	0.137	0.144	0.151	
E3	3.68	3.78	3.91	0.145	0.149	0.154	
E4 (for AL product)		0.58 typ.		0.023 typ.			
E4 (for other product)		0.75 typ.		0.030 typ.			
е	1.27 BSC			0.050 BSC			
K (for AL product)	1.45 typ.			0.057 typ.			
K (for other product)	1.27 typ.			0.050 typ.			
K1	0.56	-	-	0.022	-	-	
Н	0.51	0.61	0.71	0.020	0.024	0.028	
L	0.51	0.61	0.71	0.020	0.024	0.028	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М	0.125 typ.			0.005 typ.			

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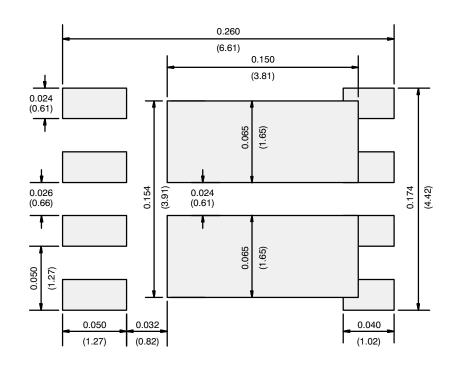
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Application Note 826

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RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Dual



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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